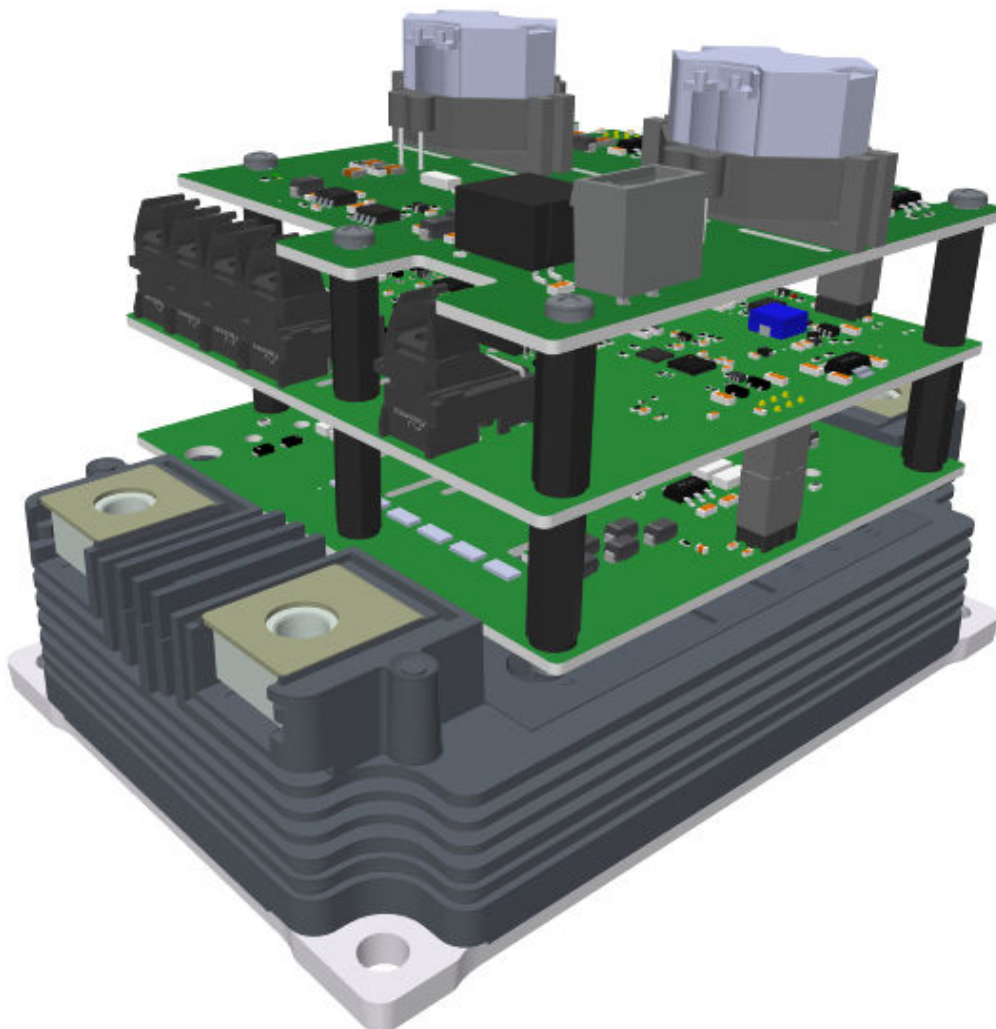


## Product Overview

Microchip XIFM plug-and-play mSiC™ gate driver is designed to drive 3.3 kV SiC modules in High-Voltage (HV) packages such as HV LinPak, HV100 XHP™, or equivalent. It features Augmented Switching™ to enhance the control of the SiC MOSFET-based power systems in normal operation and in fault conditions, such as over-current. The driver includes isolated High (HI) and Low (LO) side DC/DC converters and complies with key rail specifications—EN 50155.

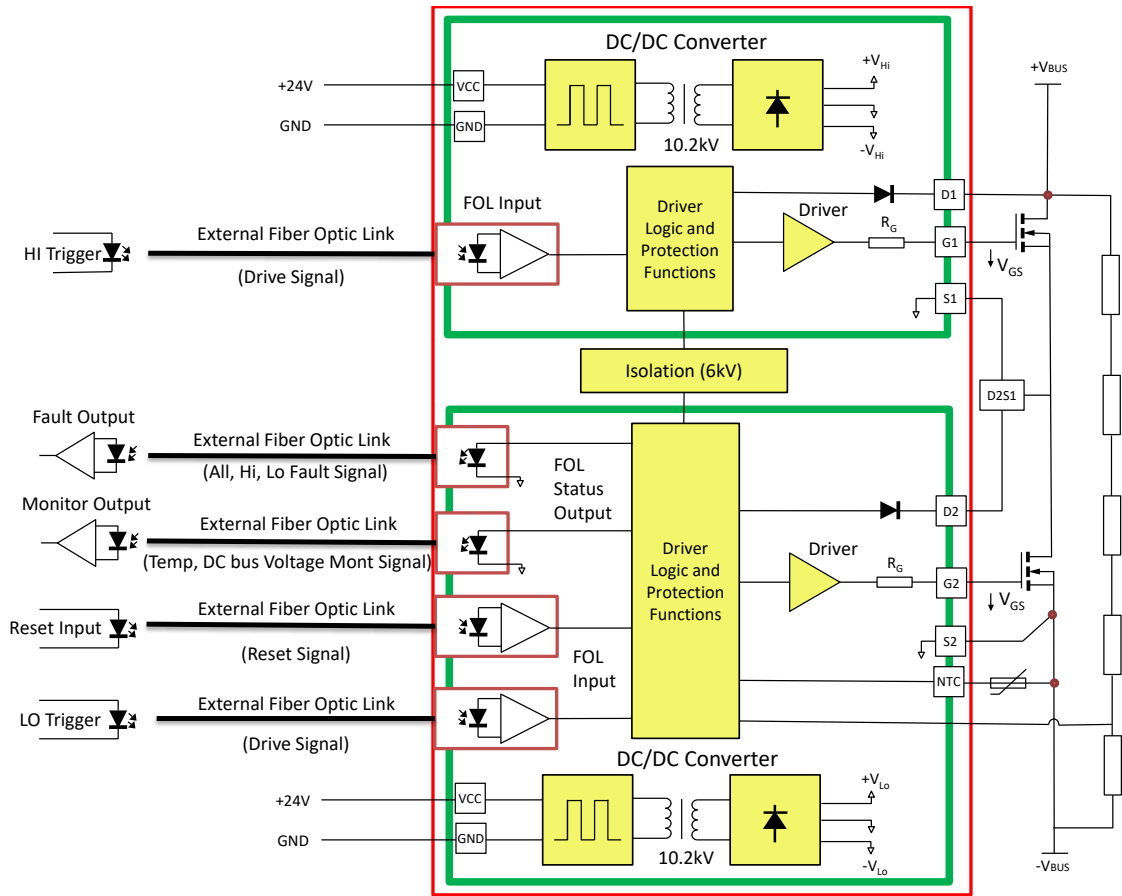
The following figure shows a representative stack-up of the gate driver, which is subject to change without notice.

**Figure 1.** XIFM Gate Driver—3D View



The following figure shows the basic topology of the XIFM gate driver.

**Figure 2.** Basic Schematic of the XIFM Gate Driver



The following table lists the fiber optic interface for XIFM gate driver.

**Table 1.** Fiber Optic Interface

| Interface                  | Description             | Part Number               |
|----------------------------|-------------------------|---------------------------|
| HI trigger input—J5        | Fiber optic receiver    | FR05DVCR                  |
| LO trigger input—J4        | Fiber optic receiver    | HFBR-2531ETZ <sup>1</sup> |
| Reset input—J1             | Fiber optic receiver    |                           |
| All fault output—J3        | Fiber optic transmitter | FT05MVNR                  |
| HV/Temp. monitor output—J2 | Fiber optic transmitter | HFBR-1531ETZ <sup>1</sup> |

**Note:**

1. This part number is used in the assembly on special request.

The following table lists the electrical connector for XIFM gate driver.

**Table 2.** Electrical Connector

| Interface | Description            | Part Number     |
|-----------|------------------------|-----------------|
| J1        | 24V On-board connector | 231-132/001-000 |

## Features

The following sections describes the features of the XIFM gate driver.

### 1.1 Software Programmable Features

The XIFM gate driver has the following software programmable features:

- Augmented switching
- Power supply Under-Voltage Lockout (UVLO)
- Desaturation detection settings
- Fault lockout settings
- Automatic reset settings
- Positive and negative gate voltage biasing
- Negative Temperature Coefficient (NTC) based measurement settings

### 1.2 Key Switch Driver Features

The XIFM gate driver has the following key switch driver features:

- Compatible with HV LinPak, HV100 XHP, or any equivalent package
- 10.2 kV primary-to-secondary isolation voltage
- Isolated temperature and DC link monitoring
- $2 \times 10\text{W}$  output power
- 15A peak source/sink current
- Configurable gate output voltages
- Compact three boards stack on-board isolated solution
- Soft shutdown time and voltage level

## Applications

The XIFM gate driver has the following applications:

- High-speed trains, traction, and hybrid trains
- Railway/Transportation
- Grid
- DC/DC

## Standards Compliance Targets

The XIFM gate driver has the following standards compliance targets:

- Railway application compliant to EN50155
- Electromagnetic Compatibility (EMC) compliant to EN 50121-3-2 and EN 61000-6-4
- Shock and vibration to EN 61373
- Fire hazard level—HL2

## 1. Electrical Specifications

The following sections describes the electrical specifications of the XIFM intelligent plug-and-play 3.3 kV gate driver.

### 1.1 Absolute Maximum Ratings

The following table lists the absolute maximum ratings of the XIFM gate driver.

**Table 1-1.** Absolute Maximum Ratings

| Parameter                             | Description                                                                                         | Min. | Max.  | Unit        |
|---------------------------------------|-----------------------------------------------------------------------------------------------------|------|-------|-------------|
| Supply voltage                        | $V_{CC}$ to GND                                                                                     | 0    | 28    | V           |
| Peak gate current                     | Peak current allowed only for fast charge $C_{GS}$                                                  | -15  | 15    | A           |
| Output power per gate                 | —                                                                                                   | —    | 10    | W           |
| Isolation voltage                     | Primary-to-secondary, $V_{AC}$ RMS, 1 min                                                           | —    | 10200 | V           |
|                                       | Secondary-to-secondary, $V_{AC}$ RMS, 1 min                                                         | —    | 6700  |             |
| Clearance distance                    | Primary-to-secondary side                                                                           | 22   | —     | mm          |
|                                       | Secondary-to-secondary side                                                                         | 12.5 | —     |             |
| Creepage distance                     | Primary-to-secondary side                                                                           | 41   | —     |             |
|                                       | Secondary-to-secondary side                                                                         | 25   | —     |             |
| Common Mode Transient Immunity (CMTI) | Rate of change from input to output                                                                 | 100  | —     | kV/ $\mu$ s |
| Operating temperature                 | Ambient operating temperature                                                                       | -40  | 85    | °C          |
| Storage temperature                   | —                                                                                                   | -40  | 85    |             |
| Voltage measurement                   | Voltage monitoring on drain of the High-Side (HS) switch against source of the Low-Side (LS) switch | 0    | 2500  | V           |
| Temperature measurement               | NTC thermistor-based monitoring <sup>1</sup>                                                        | -40  | 150   | °C          |

**Note:**

1. Software configurable parameter.

### 1.2 Electrical Characteristics

The following table lists the electrical characteristics of the XIFM gate driver.

**Note:** Conditions:  $V_{SUP} = 24V$  and MOSFET = SiC module 5SFG 0500Z330100.

**Table 1-2.** Electrical Characteristics

| Parameter                                      | Description                                    | Min. | Typ. | Max. | Unit |
|------------------------------------------------|------------------------------------------------|------|------|------|------|
| <b>Power Supply</b>                            |                                                |      |      |      |      |
| Supply voltage                                 | $V_{CC}$ to GND                                | 22   | 24   | 27   | V    |
| Supply current                                 | Without load                                   | 80   | 85   | 90   | mA   |
|                                                | With load <sup>1</sup>                         | —    | —    | 340  |      |
| Over-Voltage Lockout (OVLO) threshold          | Primary side                                   | —    | 27.5 | 28   | V    |
| OVLO level—HI and LO                           | Secondary side high voltage detect fault level | —    | 26.5 | —    | V    |
| UVLO level—HI and LO                           | Secondary side low voltage detect fault level  | —    | 16.5 | —    | V    |
| Coupling capacitance                           | Primary to secondary                           | —    | 11   | 12   | pF   |
| Positive biasing $V_{GS}$ voltage <sup>4</sup> | —                                              | 15   | —    | 21   | —    |
| Negative biasing $V_{GS}$ voltage <sup>4</sup> | —                                              | -10  | —    | 0    | —    |
| <b>Signal I/O</b>                              |                                                |      |      |      |      |
| Gate output voltage low <sup>2, 4</sup>        | —                                              | —    | -10  | —    | V    |
| Gate output voltage high <sup>2, 4</sup>       | —                                              | —    | 20   | —    | V    |

.....continued

| Parameter                            | Description                           | Min. | Typ.              | Max. | Unit     |
|--------------------------------------|---------------------------------------|------|-------------------|------|----------|
| Fault output (optical signal output) | Open signal output <sup>8</sup>       | —    | 1 (High on fault) | —    | Logic    |
| Turn-on gate resistance              | $R_{GON}$ <sup>6</sup>                | —    | 1.1               | —    | $\Omega$ |
| Turn-off gate resistance             | $R_{GOFF}$ <sup>6</sup>               | —    | 1.1               | —    | $\Omega$ |
| Gate-emitter capacitance             | $C_{GS}$                              | —    | 0                 | —    | nF       |
| HV/Temperature monitor output        | Open signal output <sup>3</sup>       | 0.5  | —                 | 10   | kHz      |
| Temperature range                    | -40 °C to 150 °C <sup>2</sup>         | 0.5  | —                 | 10   | kHz      |
| HV range                             | 0 to 2500V                            | 2.5  | —                 | 10   | kHz      |
| <b>MOSFET Short Protection</b>       |                                       |      |                   |      |          |
| Desaturation (DSAT) monitor voltage  | Between drain and source <sup>2</sup> | —    | 8.7               | —    | V        |
| Desaturation Time ( $T_{DSAT}$ )     | DSAT blanking time <sup>2, 7</sup>    | —    | 1                 | —    | $\mu$ s  |
| Response time after fault            | —                                     | —    | —                 | 5000 | ns       |

**Notes:**

1. The preceding SiC MOSFET dependent conditions assume SiC MOSFET module 5SFG 0500Z330100 with  $C_{iss}$  = TBD nF;  $Q_g$  = 100 nF operating at 20 kHz.
2. Software configurable parameter.
3. Shared between HV and temperature signals. One of them can be selected.
4. Total (+/-  $V_{GS}$  voltage threshold must not exceed 27V).
5. Recommended to use ferrite core at supply input lines (Würth Elektronik P/N 74270031 or 742700381) and shielded cable.
6. Can be configured as per user requirement or application dependent.
7. Hardware blanking time is set to the present value.
8. Software configurable output fault can be set as High or Low on fault, as per requirement.

## 2. Standard Compliance

The following table lists the standard compliance of the XIFM gate driver.

**Table 2-1.** Standard Compliance

| Test                     | Description                                                                                                            | Test Standard          |
|--------------------------|------------------------------------------------------------------------------------------------------------------------|------------------------|
| Dielectric test          | 10.2 kV <sub>RMS</sub> AC, 50 Hz, 1 min, primary to secondary                                                          | Type test              |
|                          | 6.7 kV <sub>RMS</sub> AC, 50 Hz, 1 min secondary to secondary                                                          | Type test              |
| Impulse test             | 18 V <sub>PK</sub> 1.2/50 $\mu$ s, primary to secondary                                                                | Type test (EN 50124-1) |
| Partial discharge        | <10 pC at 2.6 kV <sub>RMS</sub> extinction, primary to secondary                                                       | Type test              |
| Radiated immunity        | 20 V/m <sub>(RMS)</sub> , 80 MHz to 800 MHz, AM (80%, 1kHz), performance criteria A                                    | EN 61000-4-3           |
| Fast transients immunity | $\pm$ 2 kV, 5/50 ns, 5 kHz, performance criteria A                                                                     | EN 61000-4-4           |
| Surges immunity          | $\pm$ 2 kV, 42 $\Omega$ , 0.5 $\mu$ F, 1.2/50 $\mu$ s, performance criteria B                                          | EN 61000-4-5           |
| Conducted immunity       | 10 V <sub>RMS</sub> , AM (80%, 1kHz), performance criteria A                                                           | EN 61000-4-6           |
| Radiated emission        | 30 MHz to 230 MHz / 52 dB( $\mu$ V/m) to 52 dB( $\mu$ V/m) quasi-peak at 3m<br>230 MHz to 1GHz / 52dB quasi-peak at 3m | EN 61000-6-4           |
| Conducted emission       | 150 kHz to 500 kHz / 99 dB $\mu$ V quasi-peak<br>500 kHz to 30 MHz/ 93 dB $\mu$ V quasi-peak                           | EN 55016-2-1           |
| Cold test                | T <sub>TEST</sub> = -40 °C                                                                                             | Type test (EN 50155)   |
| Dry heat thermal test    | T <sub>TEST</sub> = 85 °C                                                                                              | Type test (EN 50155)   |
| Cycle damp heat test     | With relative humidity (90% to 100%)                                                                                   | Type test (EN 50155)   |
| Mechanical vibration     | Category 1 Class B (Functional random vibration, simulated long-life)                                                  | Type test (EN 50155)   |
| Mechanical shock         | Category 1 Class B (Body mounted)                                                                                      | Type test (EN 50155)   |

### 3. General Specifications

The following table lists the general specifications of the XIFM gate driver.

**Table 3-1.** General Specification

| Parameter                    | Description                                          | Min. | Typ. | Max. | Unit |
|------------------------------|------------------------------------------------------|------|------|------|------|
| Humidity                     | Compliant to EN 50155 railways standard <sup>1</sup> | —    | 85   | 95   | %    |
| Pollution degree             | Class 2                                              | —    | —    | —    | —    |
| Environmental compliance     | Reach compliant                                      | —    | —    | —    | —    |
|                              | RoHS compliant                                       | —    | —    | —    | —    |
| Material flammability rating | UL94V-0 rated                                        | —    | —    | —    | —    |
| Fire hazard level            | HL2                                                  | —    | —    | —    | —    |

**Note:**

1. Device used with conformal coating.

## 4. Physical Specification

The following table lists the physical specifications of the XIFM gate driver.

**Table 4-1.** Physical Specification

| Parameter           | Description                                                         | Min. | Typ. | Max. | Unit |
|---------------------|---------------------------------------------------------------------|------|------|------|------|
| Length <sup>1</sup> | —                                                                   | —    | —    | 95.5 | mm   |
| Width <sup>1</sup>  | —                                                                   | —    | —    | 95   | mm   |
| Height <sup>1</sup> | —                                                                   | —    | —    | 75   | mm   |
| Weight              | Total weight of the gate driver (all three boards) <sup>2</sup>     | —    | —    | 220  | g    |
| Screw torque        | Torque on the collector, emitter, high and low side gate terminals. | 1    | —    | 1.5  | Nm   |

**Notes:**

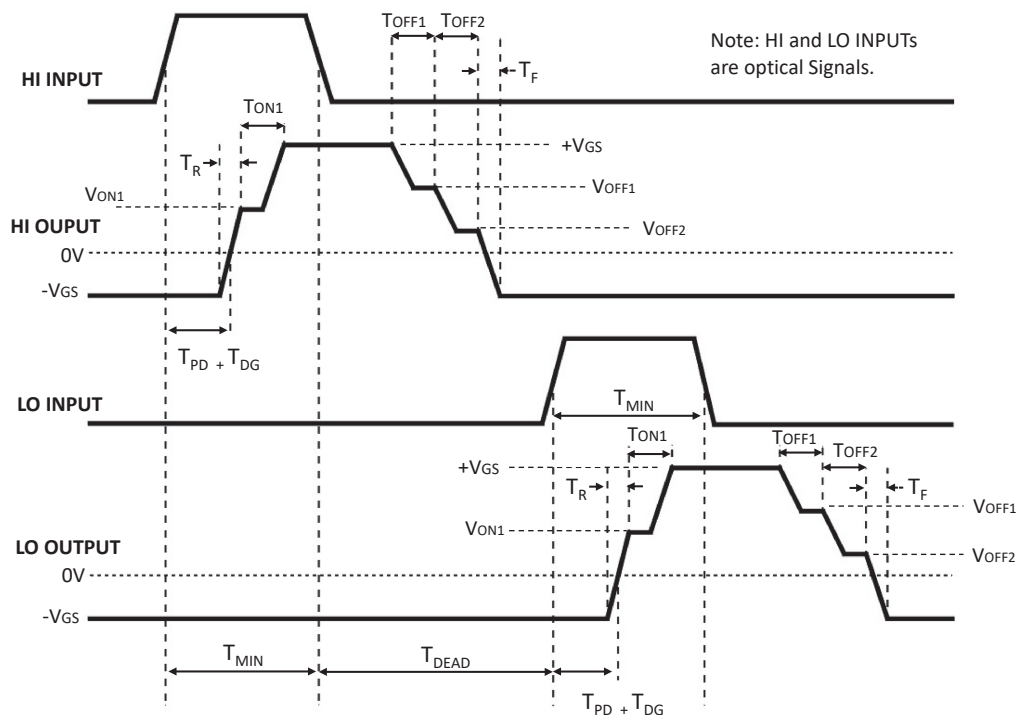
1. Dimensions have a tolerance of  $\pm 0.5$  mm.
2. Weight can have tolerance of  $\pm 10$ g.



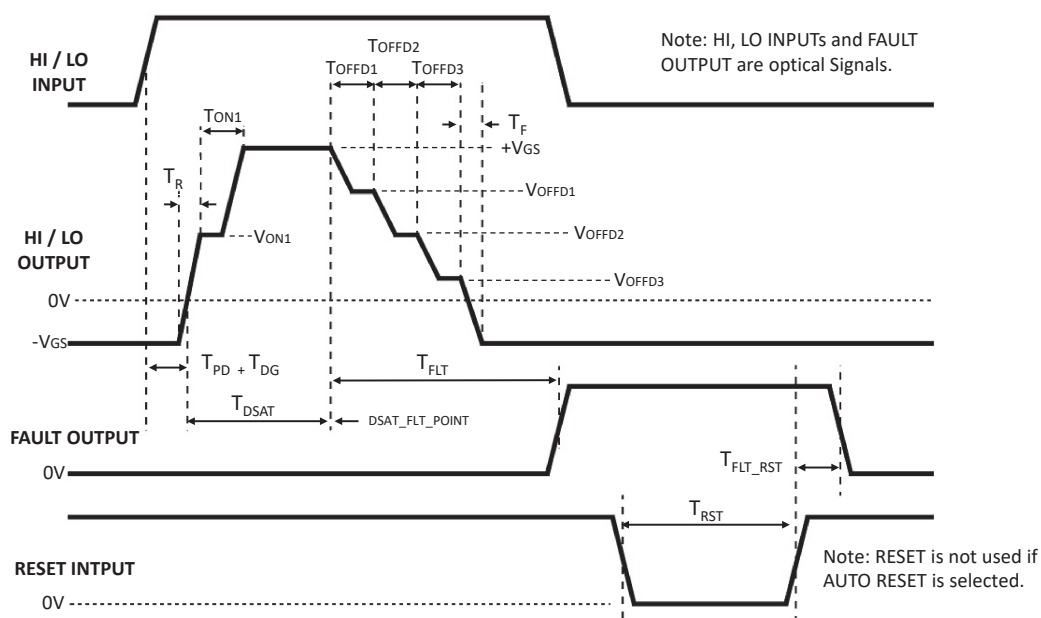
## 5. Timing Diagrams

The following figures show the timing diagrams of the XIFM gate driver.

**Figure 5-1.** Signal Input/Output Timing Diagram for Normal Operation



**Figure 5-2.** Signal Desaturation and Fault Timing Diagram



## 5.1 Timing Diagram Values

The following table lists the timing diagram values of the XIFM gate driver.

**Note:** Condition  $V_{SUP} = 24V$ , Temp. = 0 °C to 85 °C.

**Table 5-1.** Timing Diagram Values

| Parameter                  |                                   | Description                  | Min. | Typ. | Max. | Unit |
|----------------------------|-----------------------------------|------------------------------|------|------|------|------|
| Minimum pulse width        |                                   | $T_{MIN}^8$                  | —    | —    | —    | ns   |
| Propagation delay          |                                   | $T_{PD}^{1,3}$               | —    | —    | 280  | ns   |
| De-glitch time             |                                   | $T_{DG}^4$                   | —    | 200  | —    | ns   |
| Rise time                  |                                   | $T_R^{2,3}$                  | —    | 35   | —    | ns   |
| Fall time                  |                                   | $T_F^{2,3}$                  | —    | 30   | —    | ns   |
| Two-level turn-on          | First step turn-on time           | $T_{ON1}^4$                  | —    | 200  | —    | ns   |
|                            | First step turn-on voltage        | $V_{TON1}^4$                 | —    | 9.5  | —    | V    |
| Multi-level turn-off step  | First step turn-off time          | $T_{OFF1}^4$                 | —    | 200  | —    | ns   |
|                            | First step turn-off voltage       | $V_{OFF1}^4$                 | —    | 9.5  | —    | V    |
|                            | Second step turn-off time         | $T_{OFF2}^4$                 | —    | 200  | —    | ns   |
|                            | Second step turn-off voltage      | $V_{OFF2}^4$                 | —    | 4.5  | —    | V    |
| DSAT voltage level         |                                   | $V_{DSAT}^4$                 | —    | 8.7  | —    | V    |
| DSAT blanking time         |                                   | $T_{DSAT}^{4,5}$             | 1000 | 1100 | 1200 | ns   |
| DSAT de-glitch time        |                                   | $T_{DSAT\_DG}^4$             | —    | 0    | —    | ns   |
| DSAT turn-off steps        | First step DSAT turn-off time     | $T_{OFFD1}^4$                | —    | 250  | —    | ns   |
|                            | First step DSAT turn-off voltage  | $V_{OFFD1}^4$                | —    | 9.5  | —    | V    |
|                            | Second step DSAT turn-off time    | $T_{OFFD2}^4$                | —    | 250  | —    | ns   |
|                            | Second step DSAT turn-off voltage | $V_{OFFD2}^4$                | —    | 6.5  | —    | V    |
|                            | Third step DSAT turn-off time     | $T_{OFFD3}^4$                | —    | 250  | —    | ns   |
|                            | Third step DSAT turn-off voltage  | $V_{OFFD3}^4$                | —    | 2.5  | —    | V    |
| Fault time delay           |                                   | $T_{FLT}^7$                  | —    | 5000 | —    | ns   |
| Fault reset                |                                   | $T_{FLT\_RST}$               | —    | 1000 | —    | ns   |
| Dead time-input            |                                   | $T_{DEAD}^6$                 | —    | 500  | —    | ns   |
| Reset timing               |                                   | $T_{RST}$ Minimum reset time | —    | 1000 | —    | ns   |
| Automatic reset (optional) |                                   | —                            | —    | 5    | —    | ms   |

### Notes:

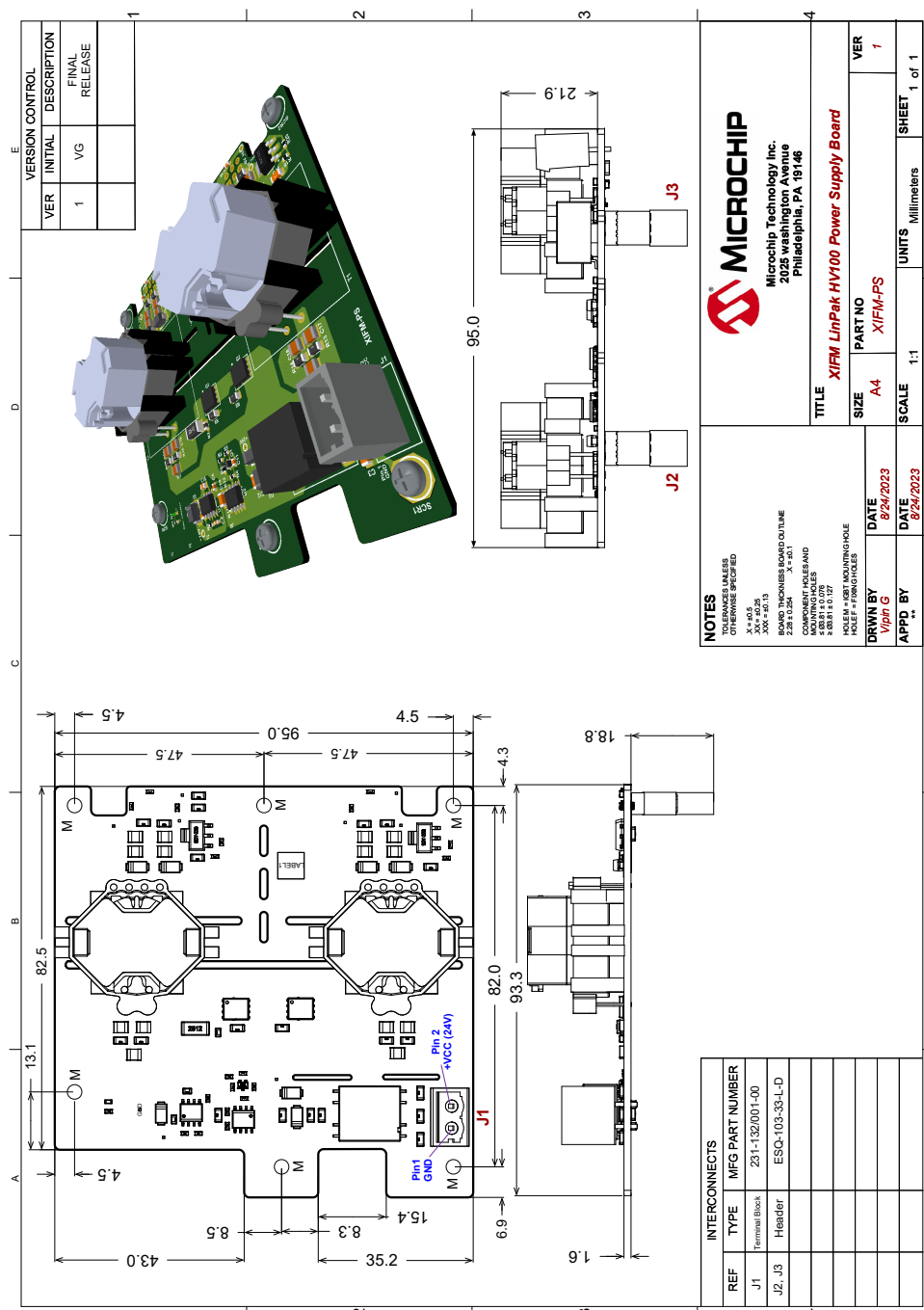
1. Measured from 50% to 50% of input trigger and output  $V_{GS}$  signal.
2. Measured from 10% to 90% of output  $V_{GS}$  signal.
3. Measured without augmented settings and at no load condition.
4. Software configurable depends on user requirements.
5. Hardware blanking time is set to the present value in the table.
6. Death Time must be configured by the user by the host controller.
7. This is fault output delay time, but when DSAT is detected on board gate driver shuts-down trigger within 25 ns.
8. The minimum pulse width is a factor of the multi-level turn-off and two-level turn-on time.

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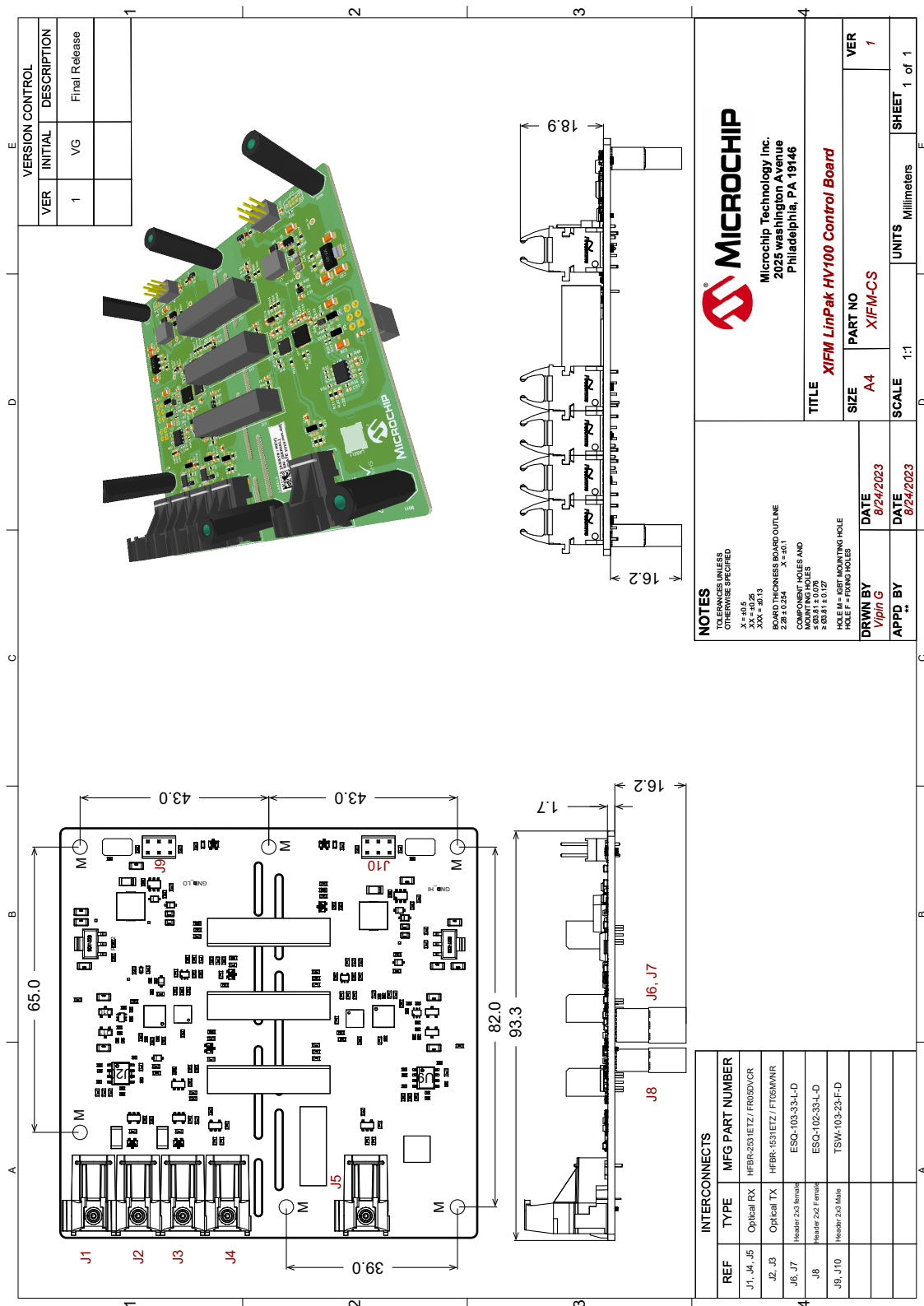


**Figure 6-1. Package Outline Drawing—XIFM LinPak HV100 Power Supply Board**



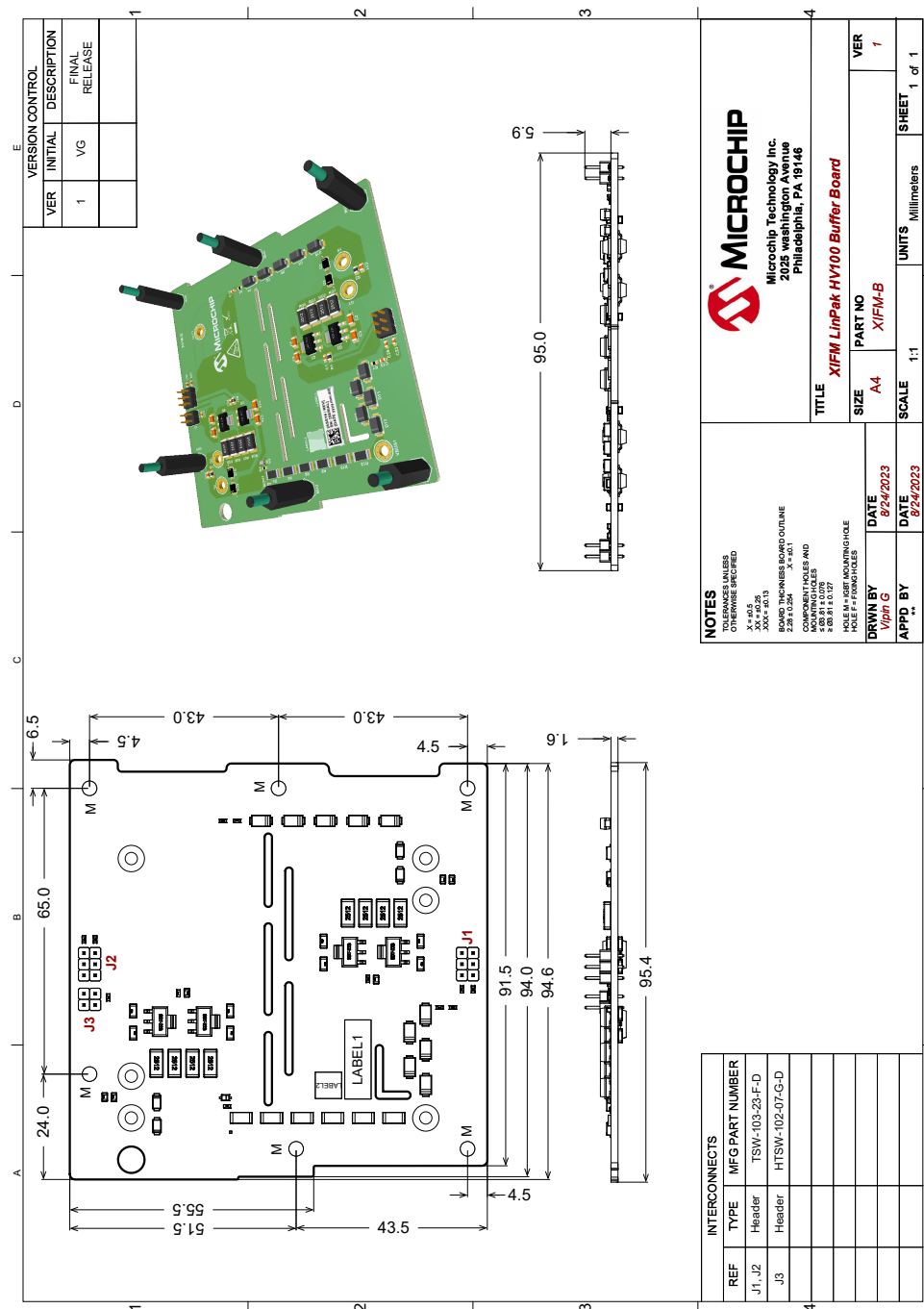
The following figure shows the package outline drawing of the XIFM LinPak HV100 control board. The dimensions in the following figure are in millimeters.

**Figure 6-2. Package Outline Drawing—XIFM LinPak HV100 Control Board**



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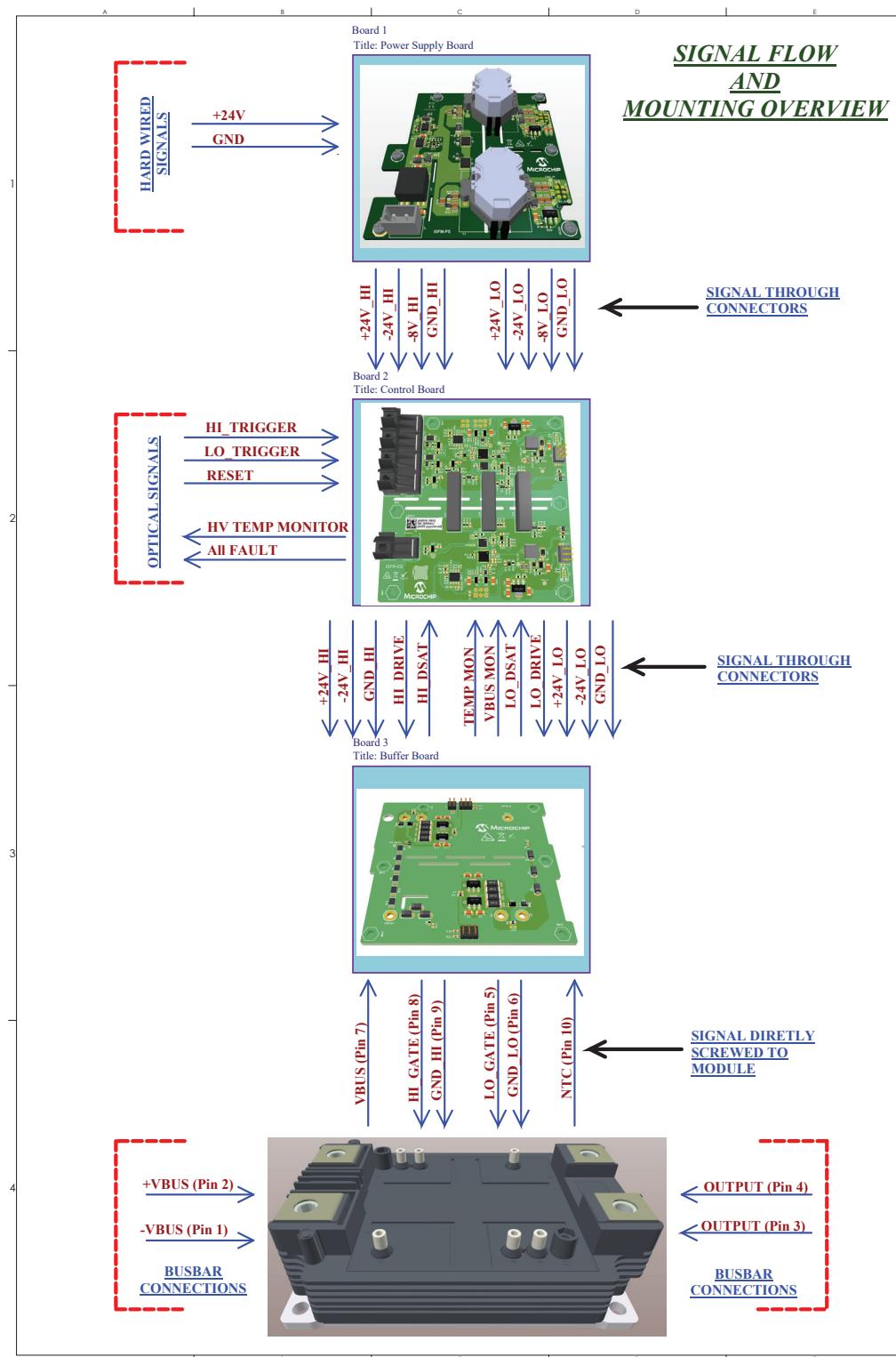
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## 6.2 Signal Flow and Mounting Overview

The following figure shows the signal flow and mounting overview of the XIFM gate driver.

**Figure 6-4.** Signal Flow and Mounting Overview



## 7. Important Precautions



Handling devices with high voltages involves risk to life. It is imperative to comply with all respective precautions and safety regulations.

Microchip assumes that the gate drive board is mounted on the SiC MOSFET prior to start-up testing. It is recommended that the user check that the SiC MOSFET power modules are operating inside the Specified Operating Area (SOA) as specified by the module manufacturer, including short circuit testing under very low load conditions.

## 8. Revision History

The revision history describes the changes that were implemented in the document. The changes are listed by revision, starting with the most current publication.

| Revision | Date    | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
|----------|---------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| D        | 11/2023 | <p>The following changes are made in this revision of the document:</p> <ul style="list-style-type: none"> <li>Updated values in <a href="#">Table 1-1</a> and <a href="#">Table 1-2</a>.</li> <li>Added <a href="#">2. Standard Compliance</a>, <a href="#">3. General Specifications</a>, <a href="#">4. Physical Specification</a>, and <a href="#">5. Timing Diagrams</a>.</li> <li>Updated <a href="#">Figure 6-1</a>, <a href="#">Figure 6-2</a>, <a href="#">Figure 6-3</a>, and <a href="#">Figure 6-4</a>.</li> </ul> |
| C        | 02/2023 | <ul style="list-style-type: none"> <li>Updated part numbers in <a href="#">Table 1</a>.</li> <li>Updated values in <a href="#">Table 1-1</a> and <a href="#">Table 1-2</a>.</li> <li>Updated <a href="#">Figure 6-3</a>, <a href="#">Figure 6-2</a>, <a href="#">Figure 6-1</a>, and <a href="#">Figure 6-4</a>.</li> </ul>                                                                                                                                                                                                    |
| B        | 12/2022 | Updated <a href="#">Table 1</a> , <a href="#">Table 1-1</a> , and <a href="#">Table 1-2</a> .                                                                                                                                                                                                                                                                                                                                                                                                                                  |
| A        | 10/2022 | Initial revision.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                              |



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